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# Coating studies on 6 GHz seamless cavities

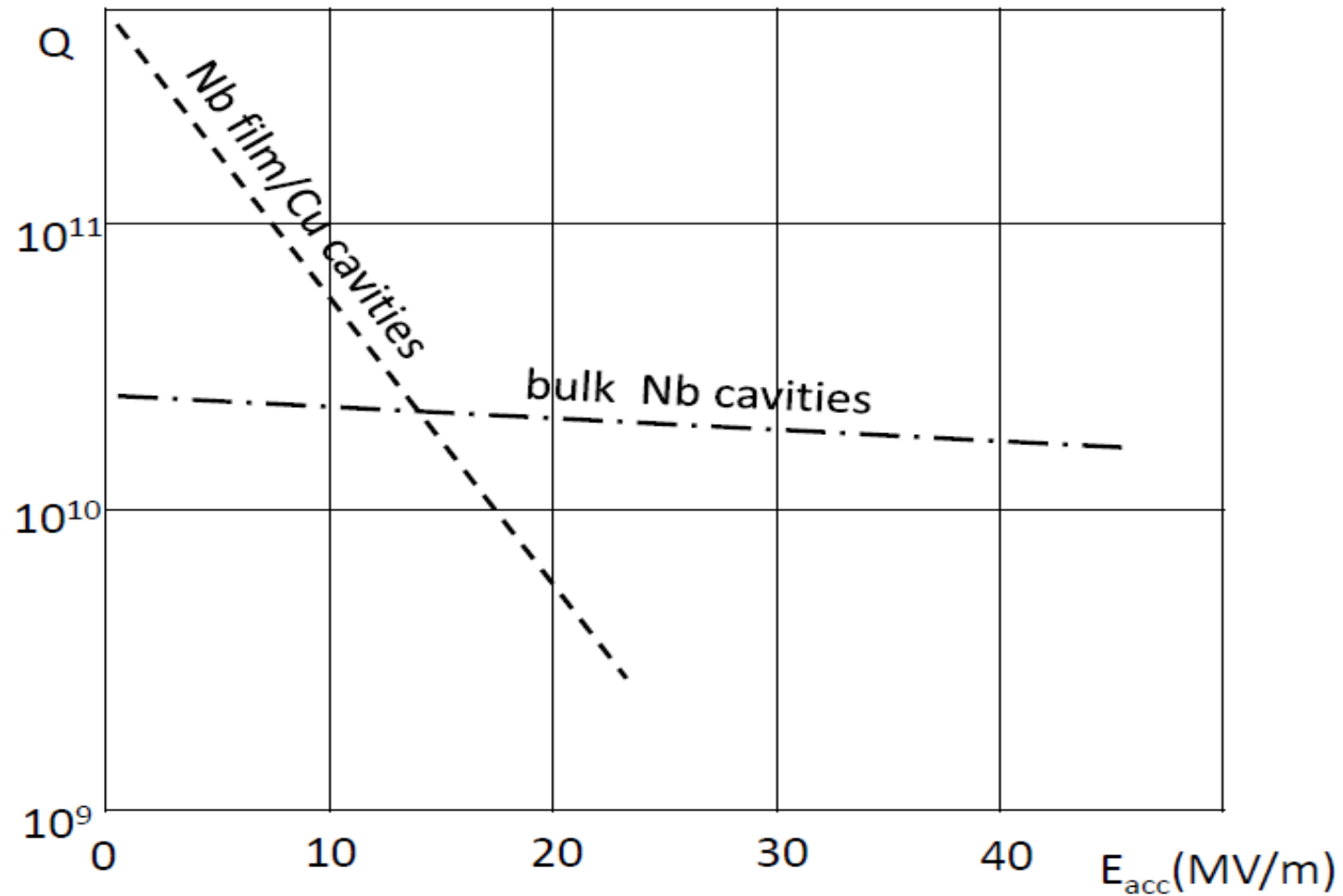
In the framework of CERN-INFN-STFC Agreement N. KE2722/BE/FCC

*FCC Week 2018, Amsterdam, 12th April 2018*

# Outline

- Q-slope problem and LNL approach
- Deposition Set Up
- Process Parameters
- Results

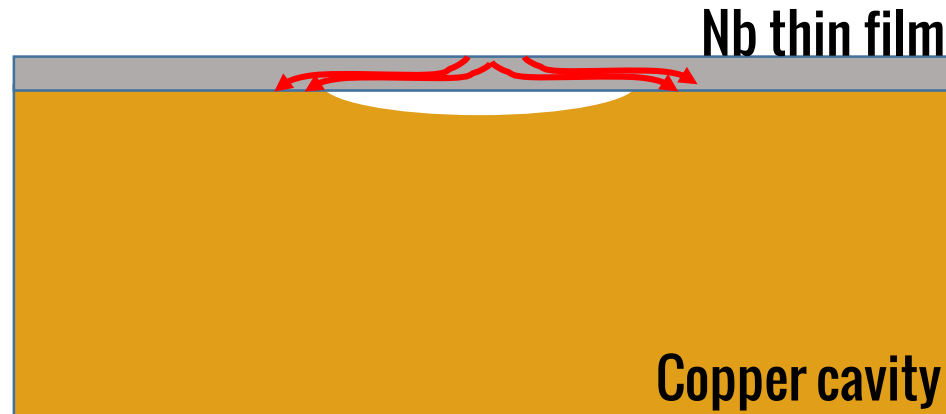
# Q-slope problem



# LNL Approach

- High temperature
- Thick films

# Thick film motivation

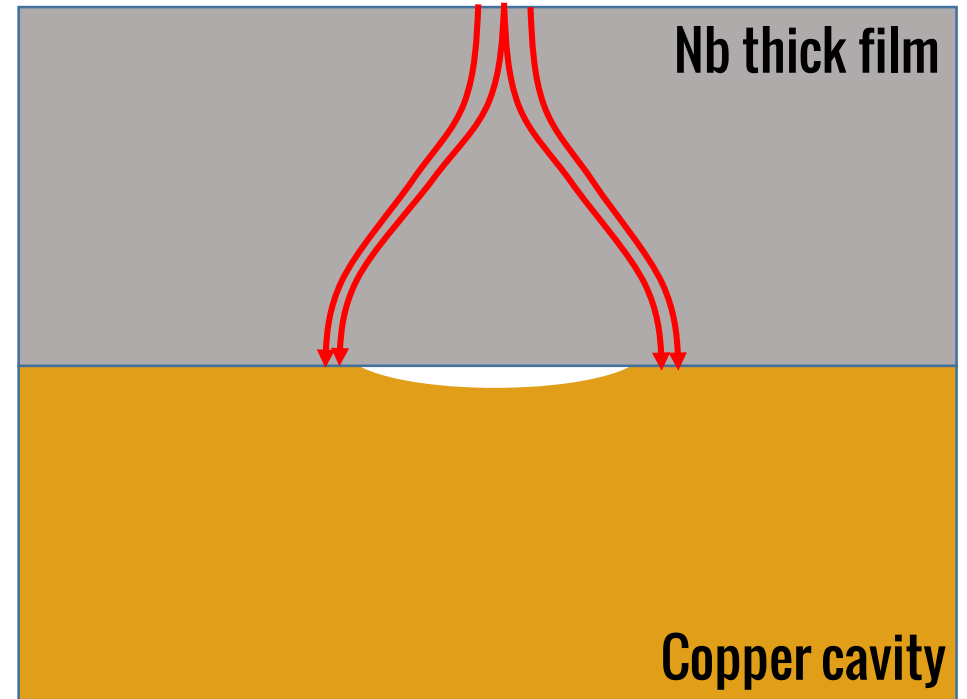
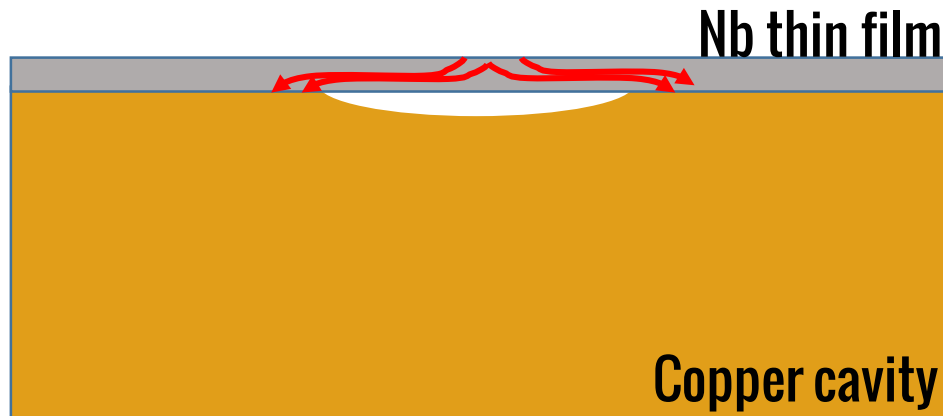


Q-slope is related to local enhancement of the **thermal boundary resistance at the Nb/Cu interface**, due to poor thermal contact between film and substrate

Theoretical model from Vaglio and Palmieri

V. Palmieri and R. Vaglio, *Supercond. Sci. Technol.*, vol. 29, no. 1, p. 015004, Jan. 2016

# Thick film motivation

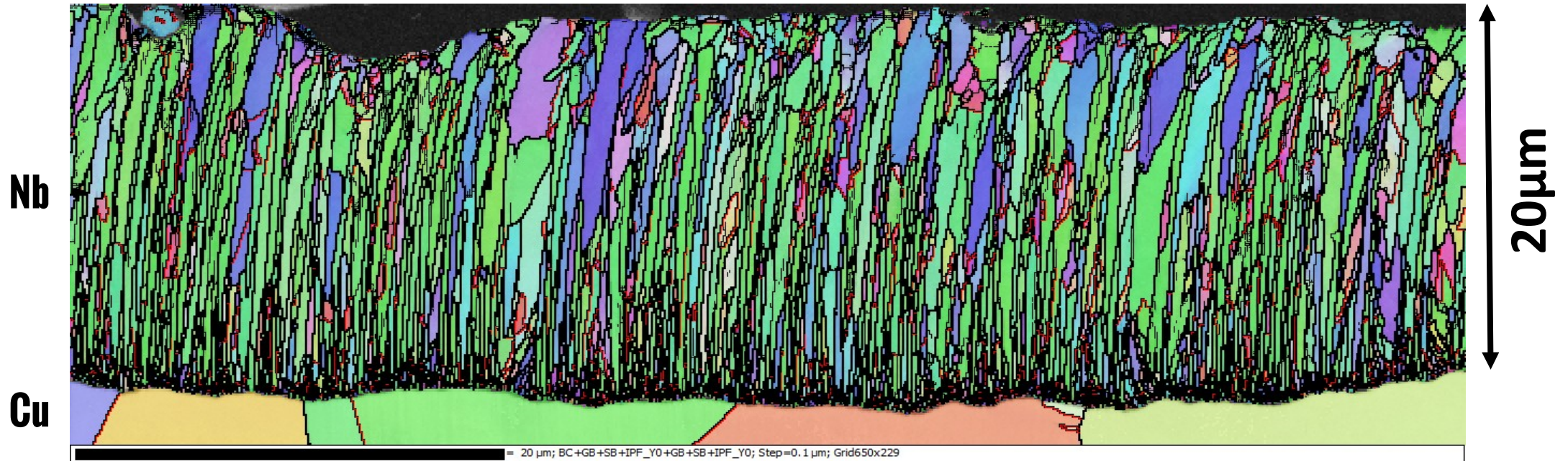


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# Thick films increase grain dimensions and RRR

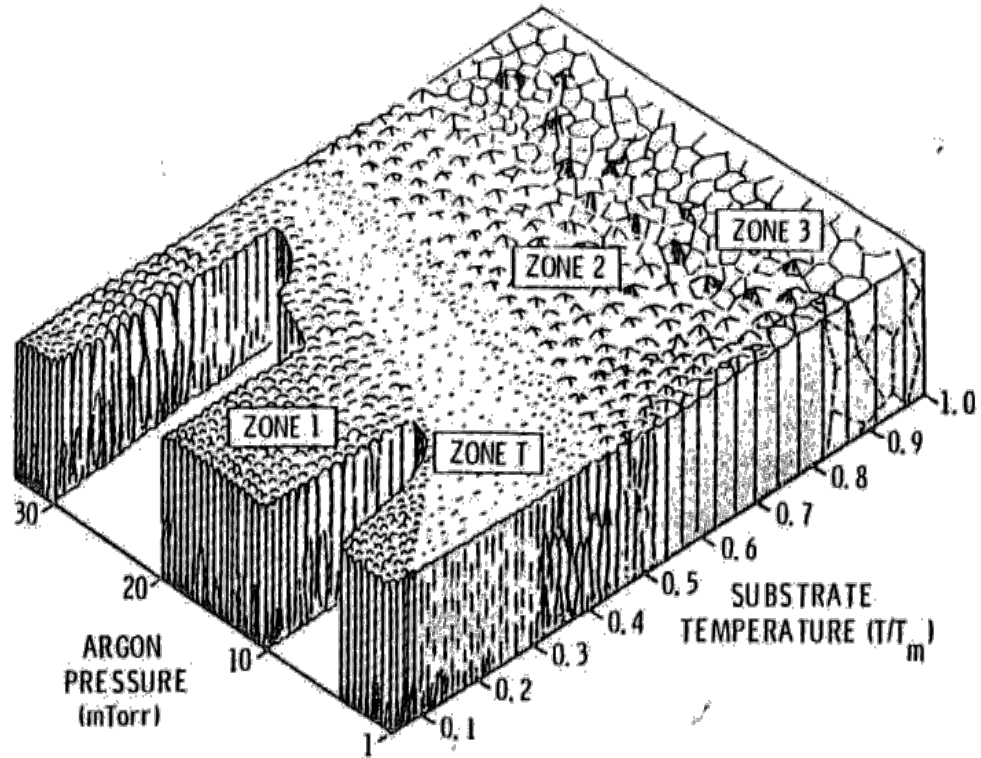


Grain dimension  $\approx 1\mu\text{m}$

RRR > 60

*EBSD Micrograph of cavity #4,  
courtesy of Reza Valizadeh (STFC)*

# High Temperature Deposition Motivation



- **Thornton SZ Diagram**

J.A. Thornton and D.W. Hoffman, *Thin Solid Films*, vol. 171, no. 1, pp. 5-31, 1989

- **CERN (550 °C)**

C. Benvenuti et al., *Physica B* 197 (1994) 72-83

- **LNL Alpi Linac (300-500 °C)**

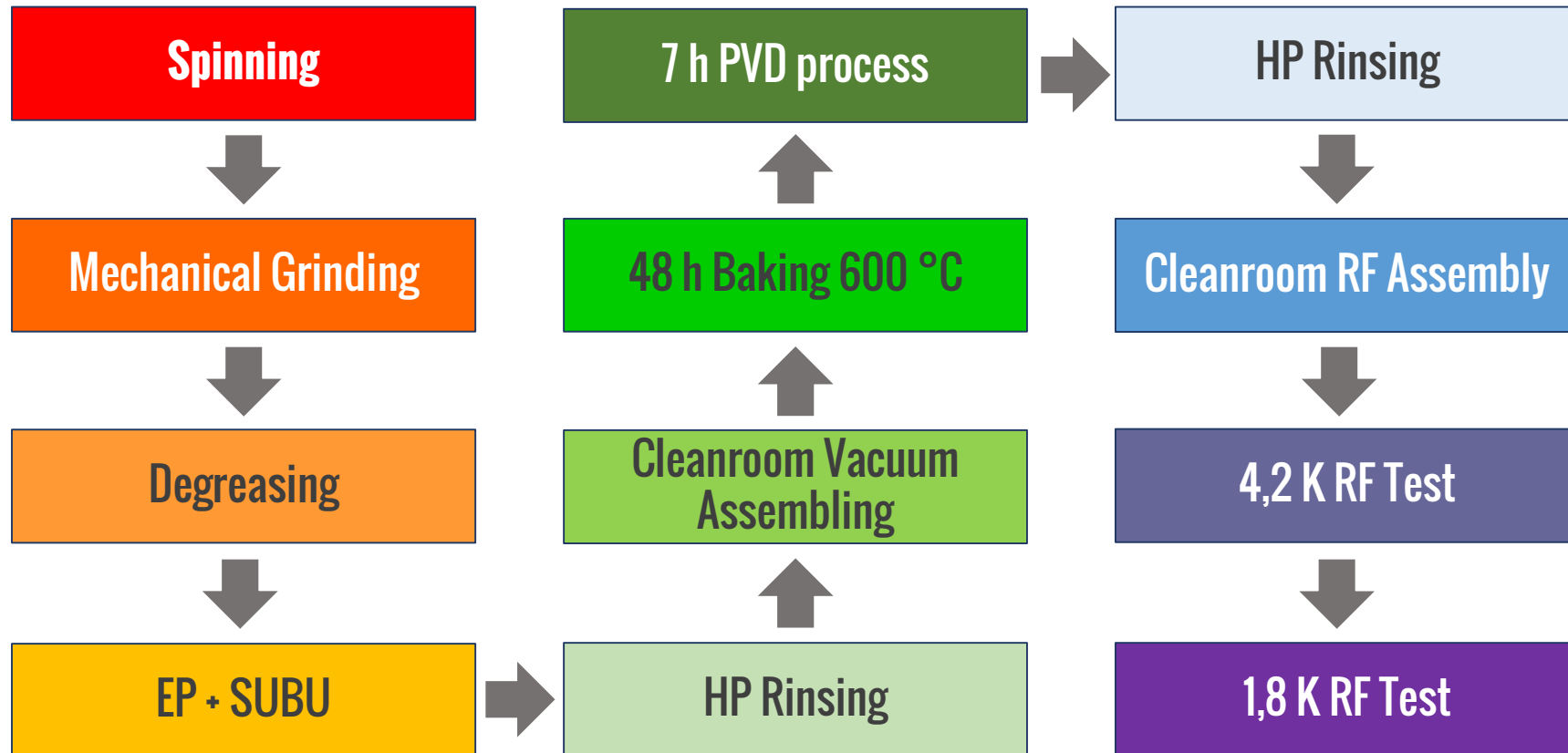
Stark et al., *Proceedings of SRF1997*

- **Hie-Isolde (650 °C)**

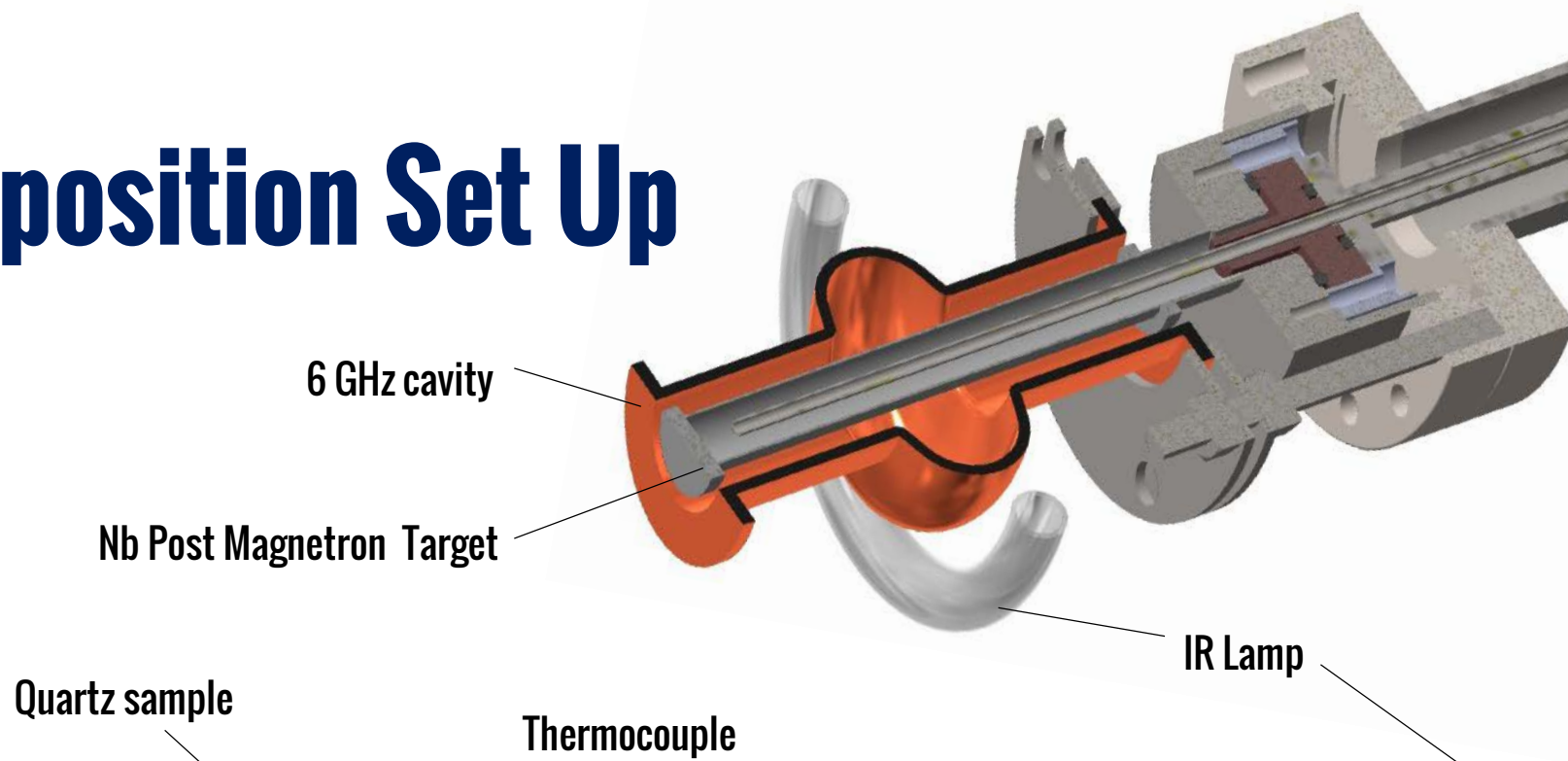
Sublet et al., *Proceedings of SRF2013*



# 6 GHz cavity coating protocol (2 weeks per cavity)



# Deposition Set Up



# Process parameters

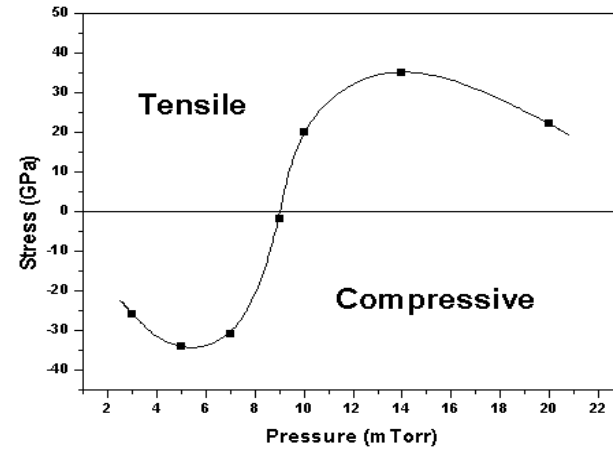
- Temperature = **550 °C** (*baking 600 °C*)
- Base pressure <  **$2 \cdot 10^{-9}$  mbar** (*room T*)
- Ar Pressure = **from  $7 \cdot 10^{-3}$  to  $5 \cdot 10^{-2}$  mbar**
- Current = **1 A** ( $0,017 \text{ A/cm}^2$ )
- Magnetic Field = **830 Gauss**
- Deposition Rate = **2,5 - 3 nm/s**



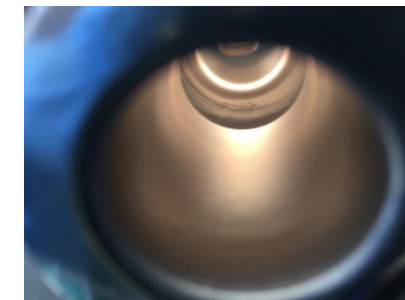
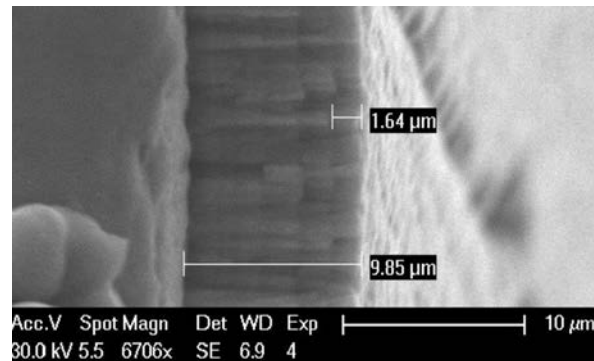
*Bending of the flange at 650 °C*

# Deposition parameters optimization

- Pressure

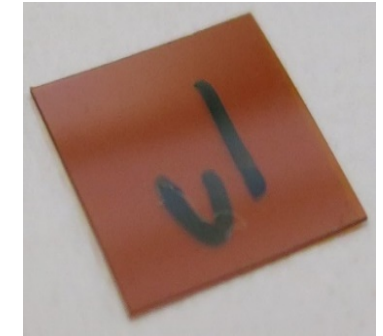
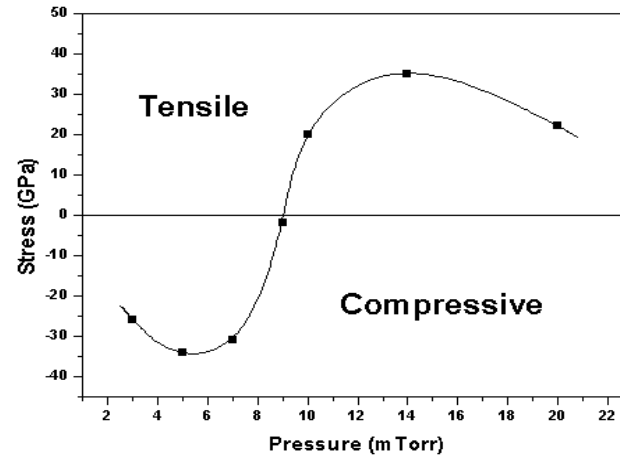


- Multilayer

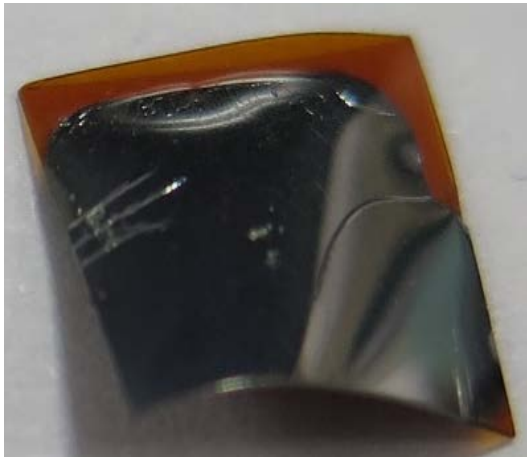


# Pressure

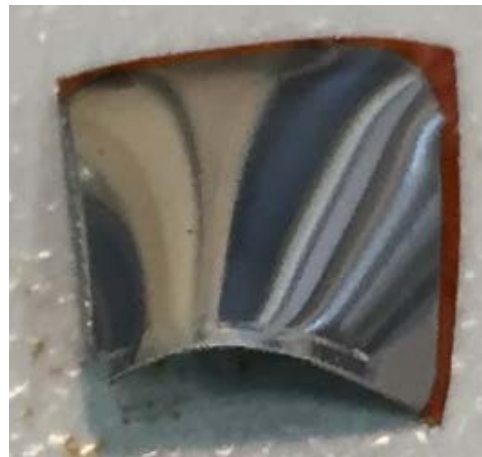
- Test on kapton foil
- Bending as a function of a pressure



300 °C



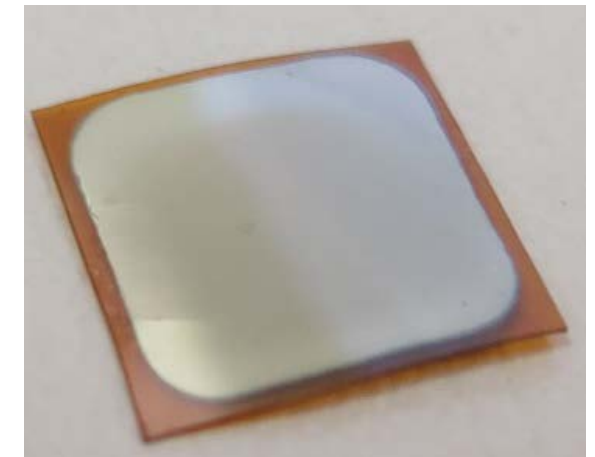
$7 \cdot 10^{-3}$  mbar



$9 \cdot 10^{-3}$  mbar



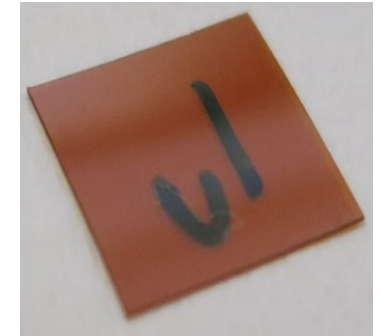
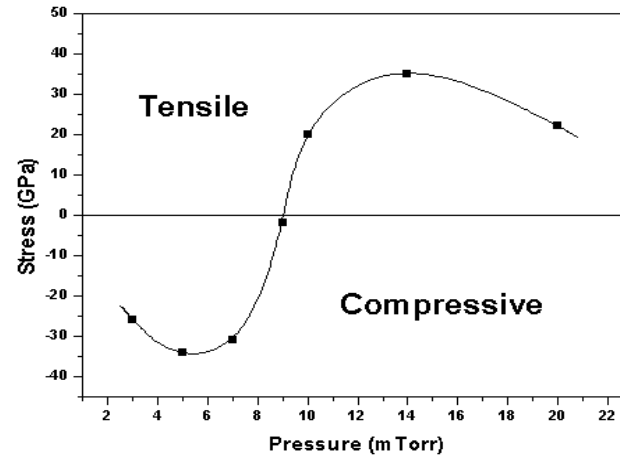
$2 \cdot 10^{-2}$  mbar



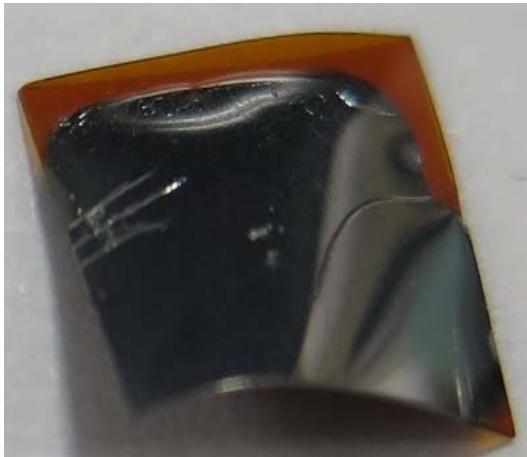
$5 \cdot 10^{-2}$  mbar

# Pressure

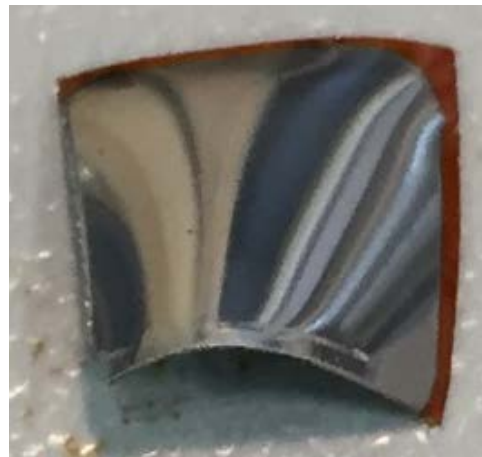
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300 °C



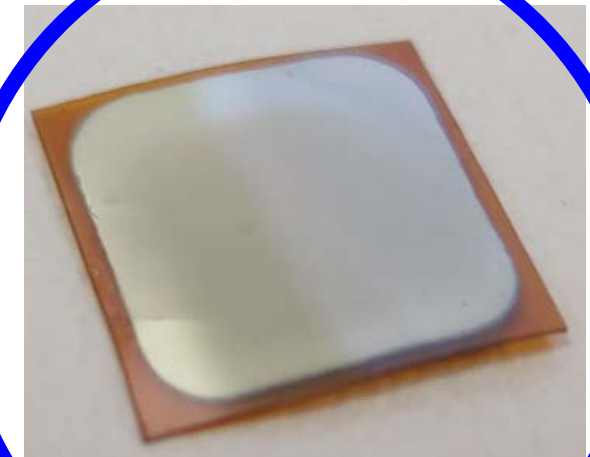
$7 \cdot 10^{-3}$  mbar



$9 \cdot 10^{-3}$  mbar

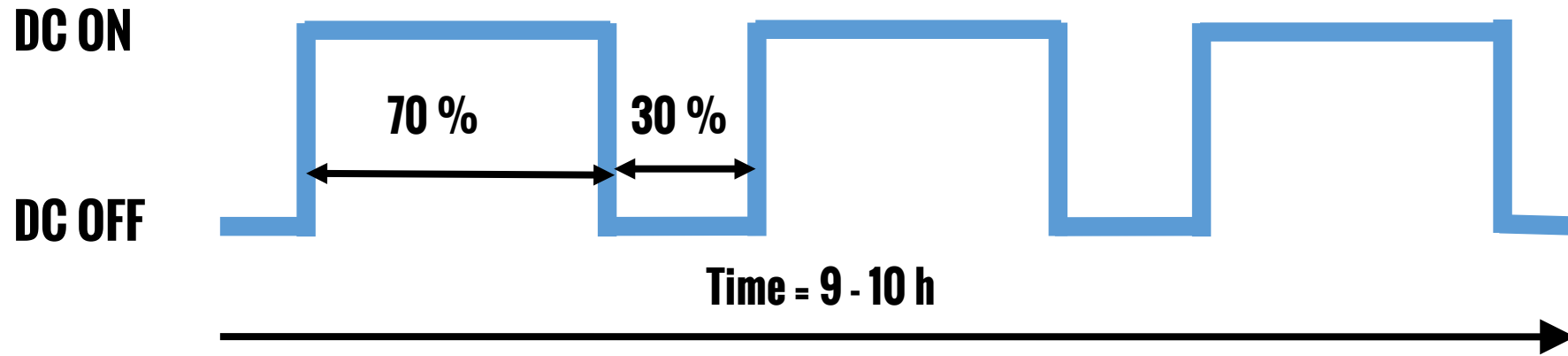


$2 \cdot 10^{-2}$  mbar



$5 \cdot 10^{-2}$  mbar

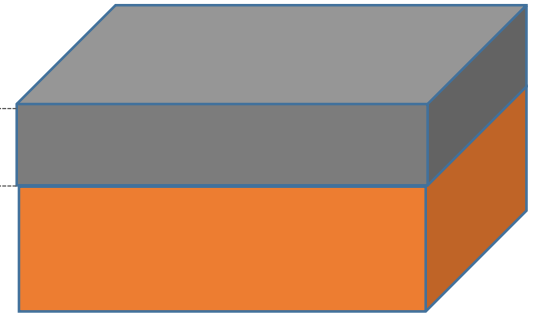
# Multilayer



Single Layer Thickness = **100, 300, 400, 500 nm**

Total Thickness (on the cell) = **70  $\mu\text{m}$**

Deposition Rate = **3 nm/s**

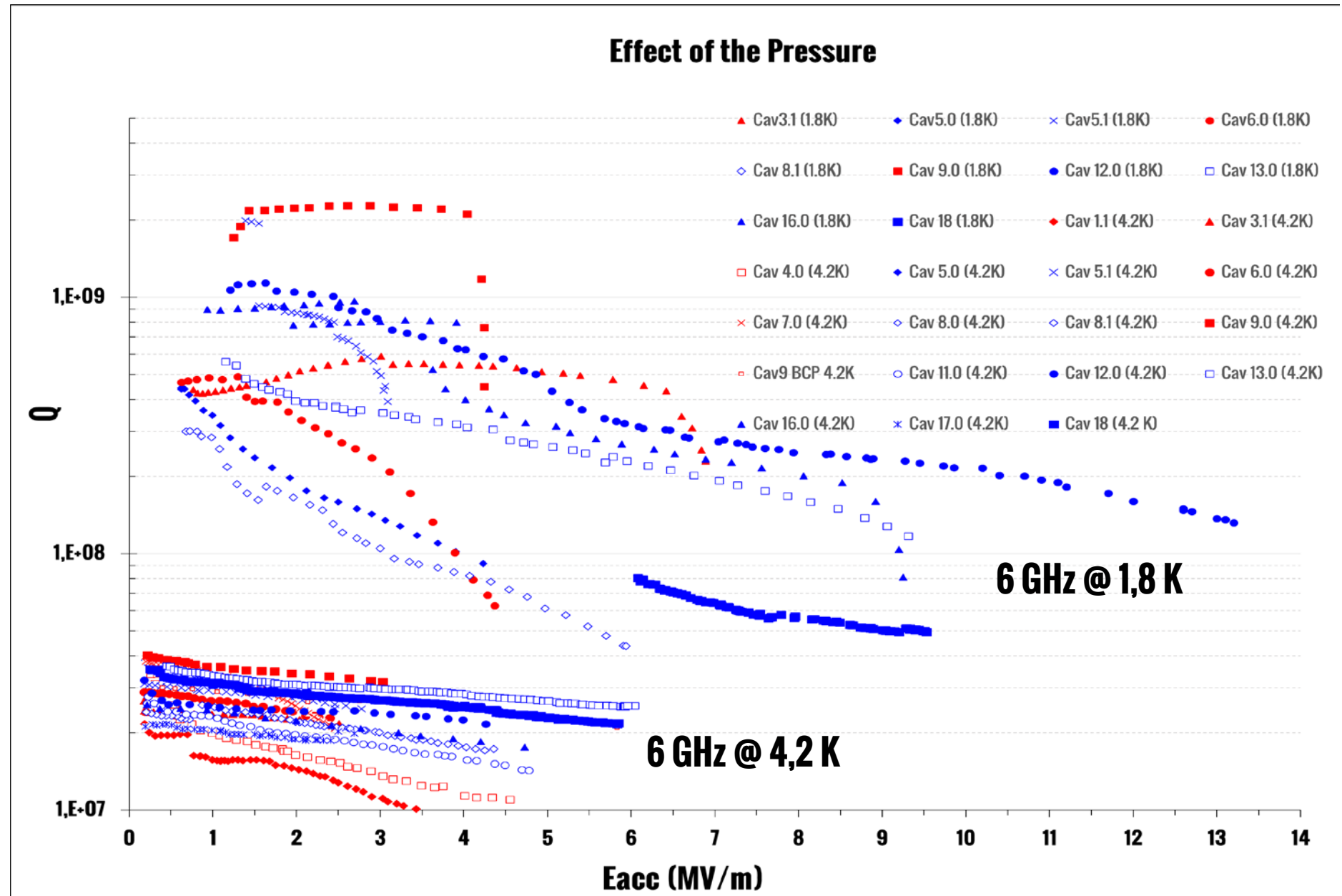


# Pressure

$5 \cdot 10^{-2}$  mbar

$7 \cdot 10^{-3}$  mbar

Zero stress pressure helps to increase accelerating gradient



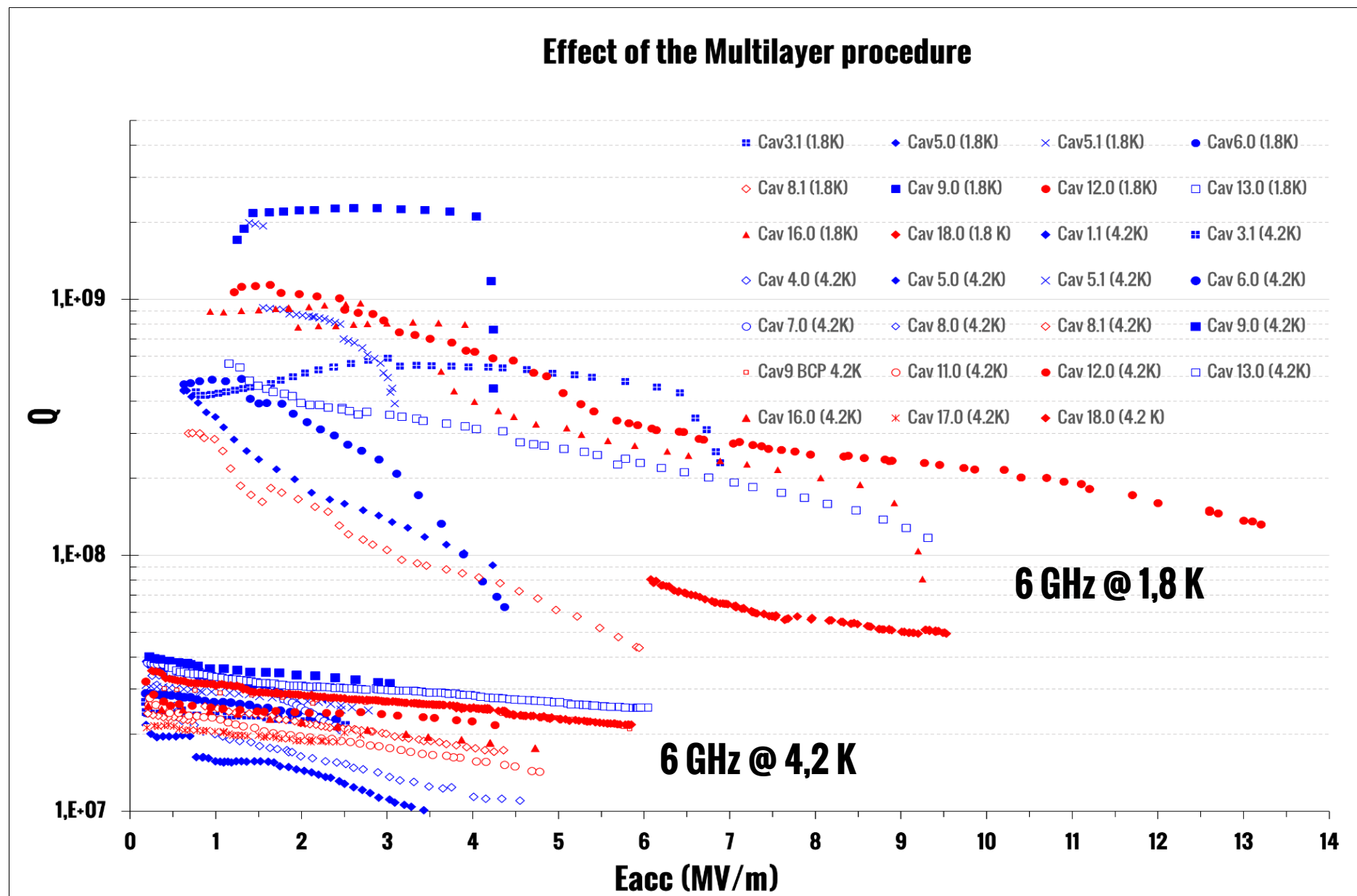


# Multilayer

One shot  
deposition

Multilayer  
Deposition

Multilayer process  
helps to increase  
accelerating gradient



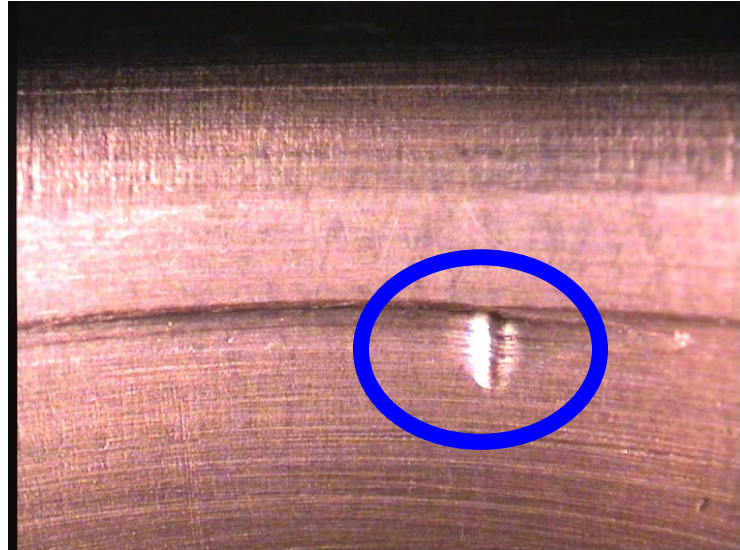
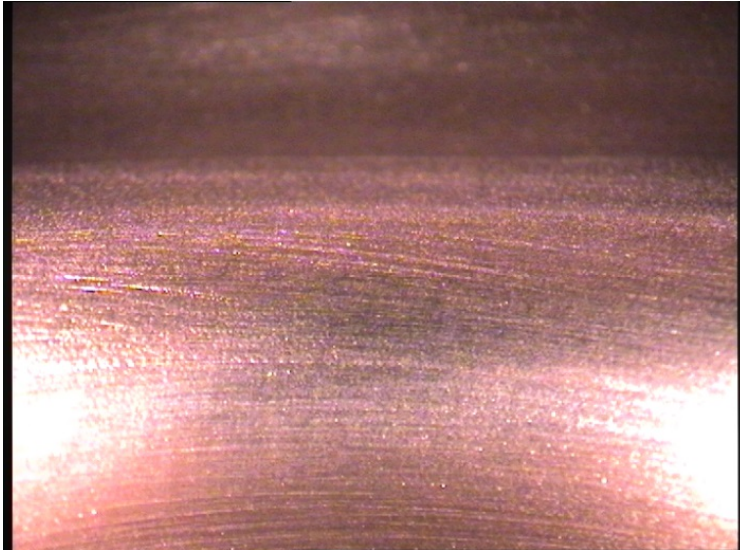
# Results interpretation

- **Sputtering pressure and multilayer deposition reduce film stress**
- **Film stress reduction reduces film peeling and voids dimension at the interface**
- **How to explain low reproducibility?**

# Cavity surface after spinning

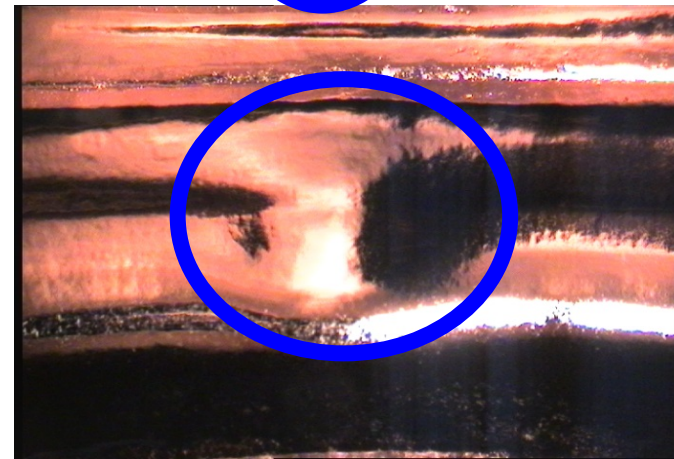
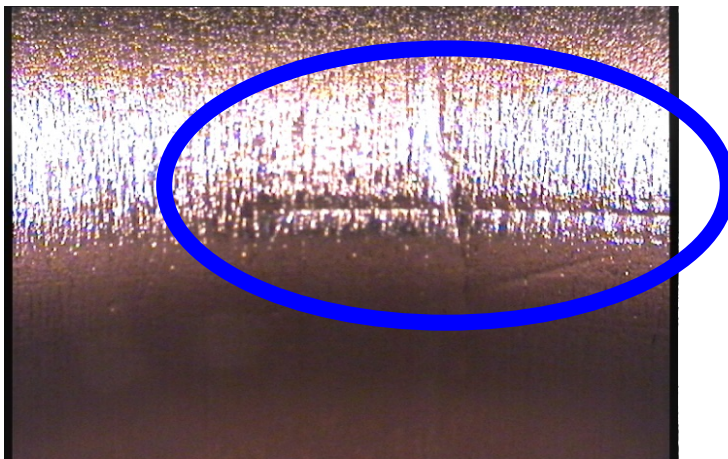
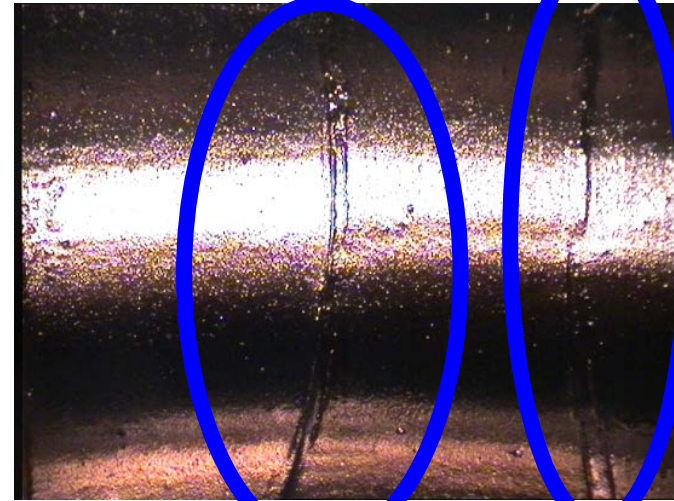
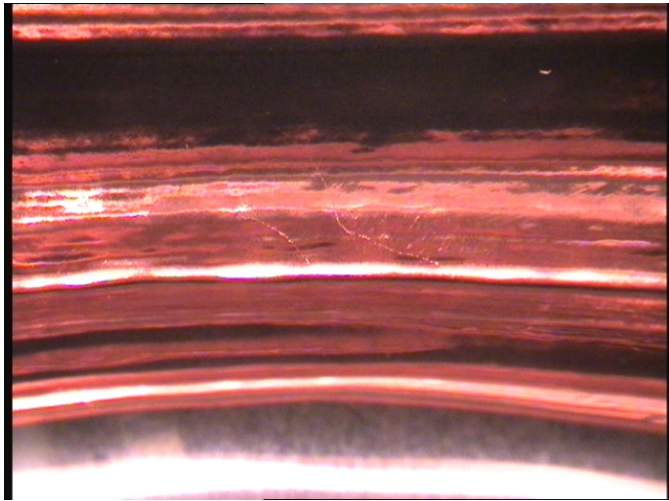


# After Mechanical Finishing



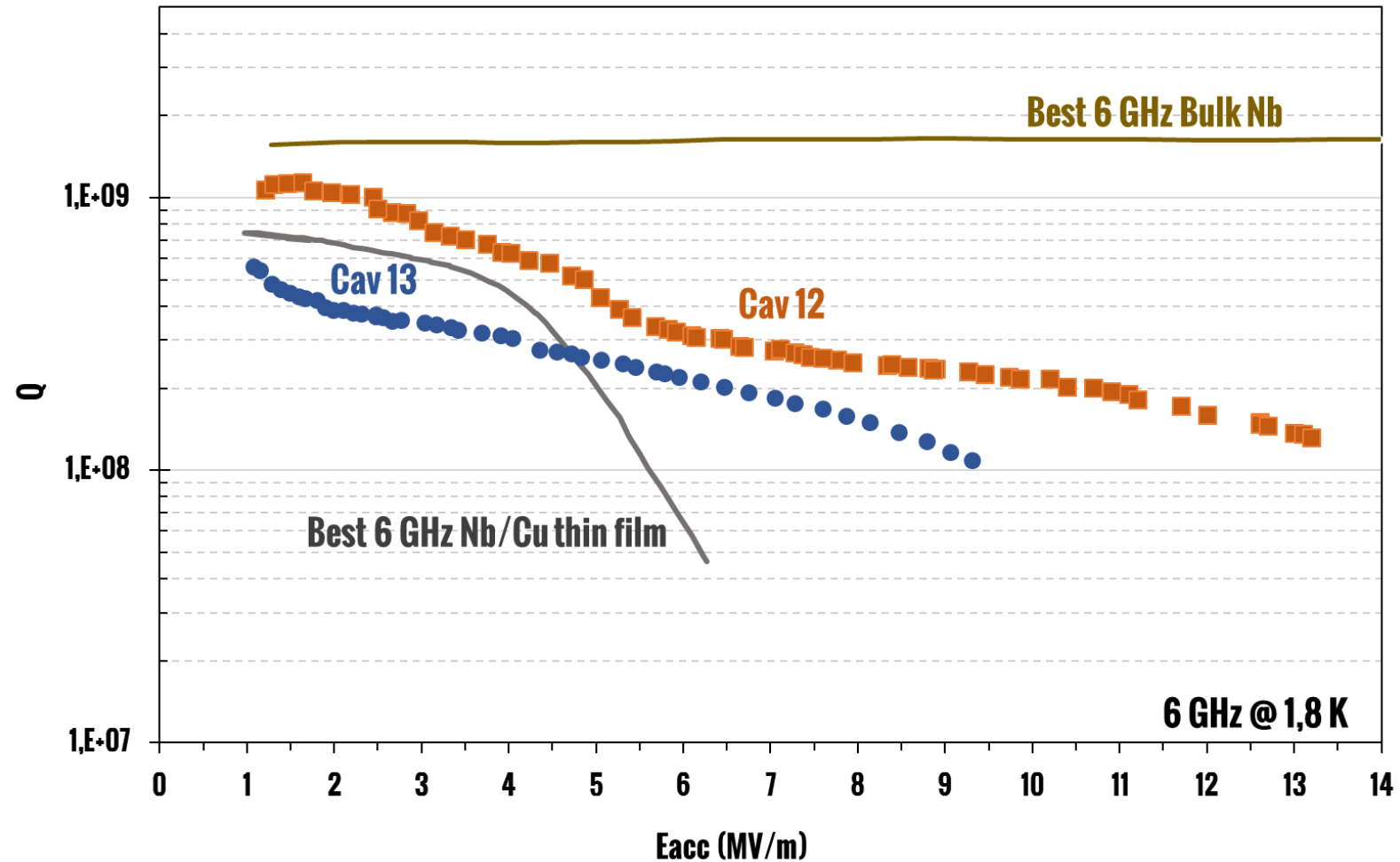
**With mechanical grinding some areas of the cell are difficult to access**

# Surface defects after chemistry

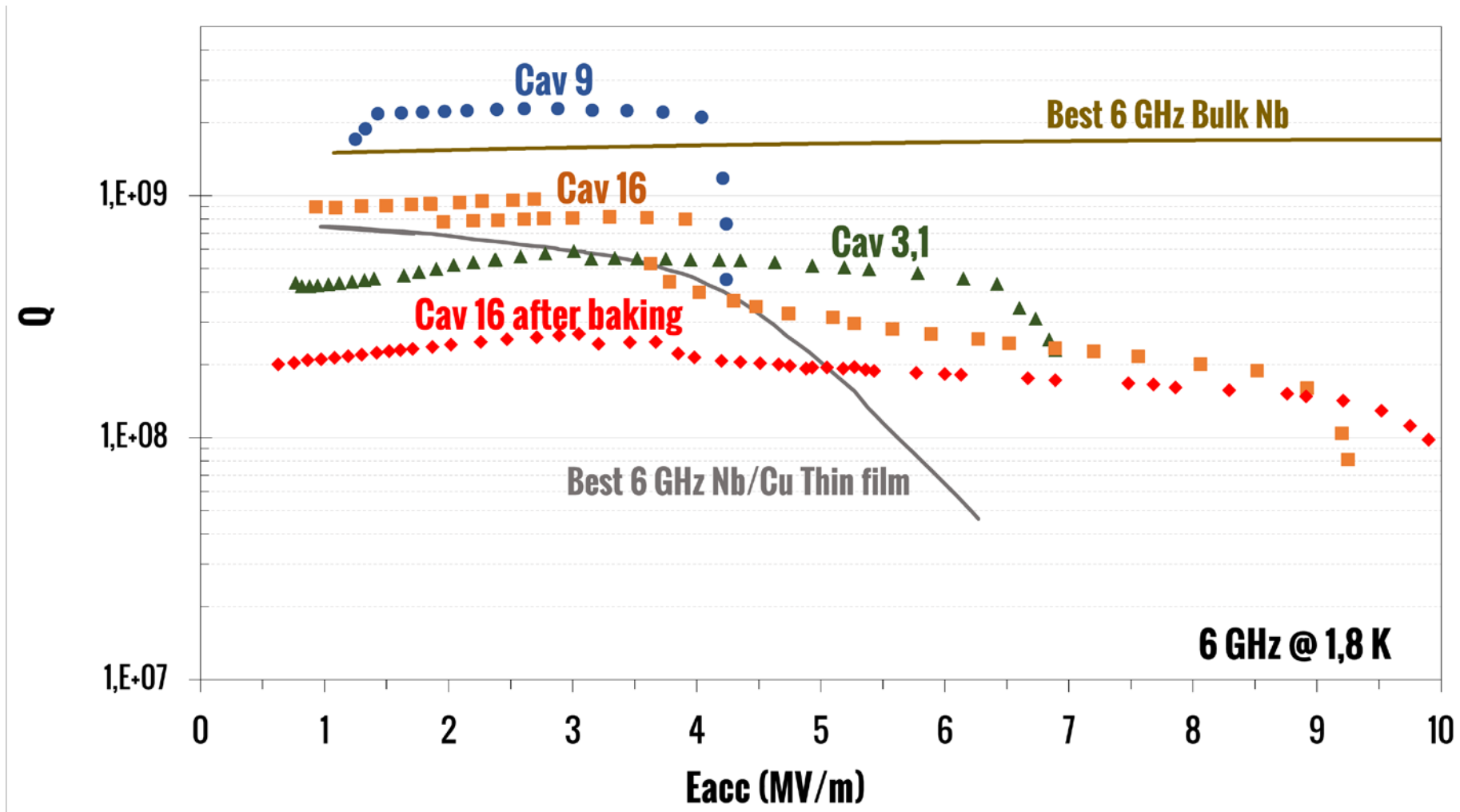


# Thick films help on Q-slope problem?

# Q-slope remains in many cavities...



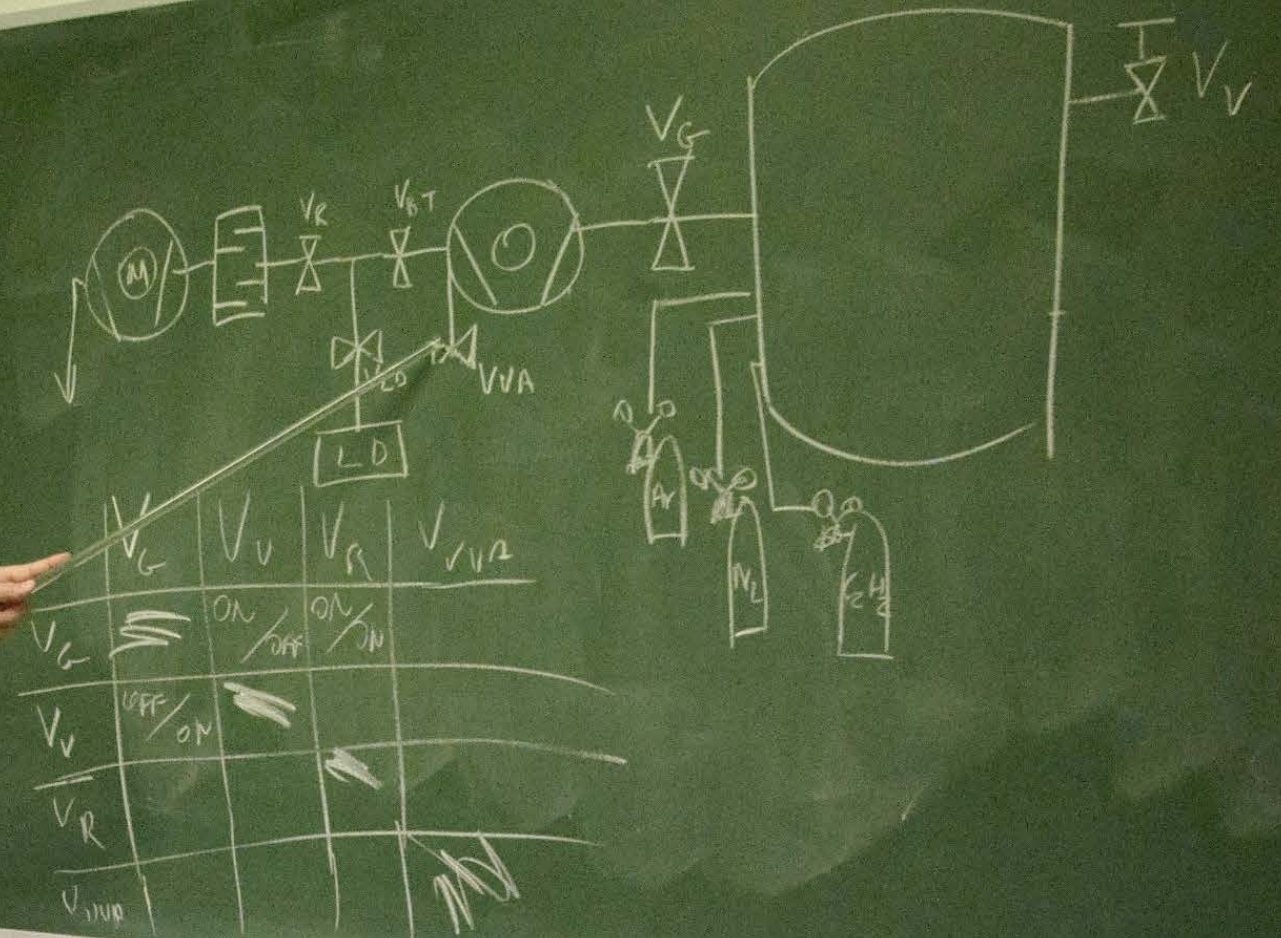
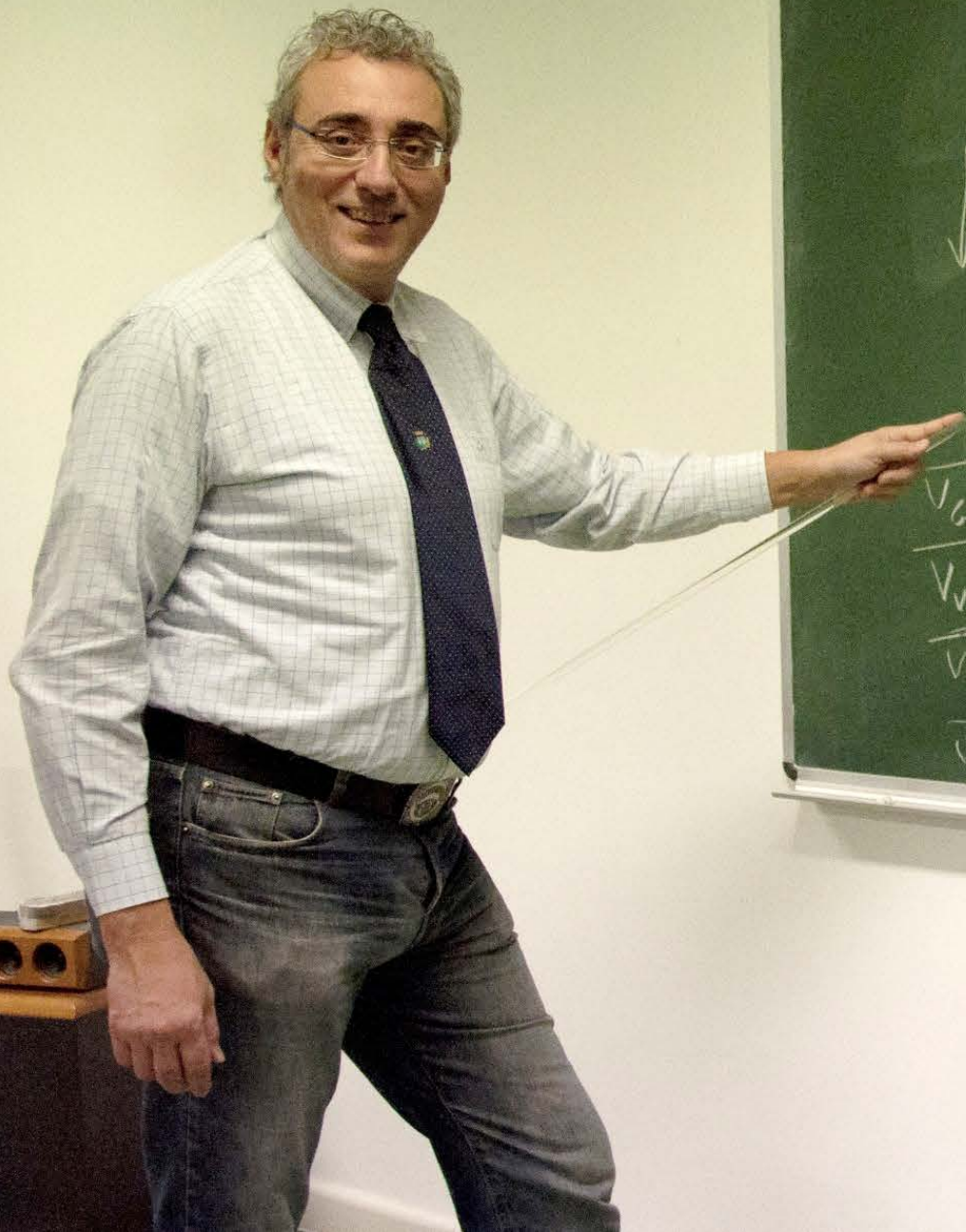
# ...but not in all ones!





# Conclusions and future actions

- We explored the thick films deposition on Nb/Cu cavities
- Strong Q-slope mitigation on 3 cavities
- The technique is very promising but not mature
- Improvements on cavity preparation process is mandatory
- Film characterization from STFC



|                  | V <sub>G</sub> | V <sub>V</sub> | V <sub>R</sub> | V <sub>V</sub> 2 |
|------------------|----------------|----------------|----------------|------------------|
| V <sub>G</sub>   | ///            | ON / OFF       | ON / ON        |                  |
| V <sub>V</sub>   | OFF / ON       | ///            |                |                  |
| V <sub>R</sub>   |                |                | ///            |                  |
| V <sub>V</sub> 2 |                |                |                | ///              |

**Enzo Palmieri**

8th International Workshop on

# **Thin Films and New Ideas for Pushing the Limits of RF Superconductivity**

**October 8-10, 2018**

**Legnaro National Laboratories INFN  
Legnaro (Padua) - Italy**